

SiRA12DP

RoHS

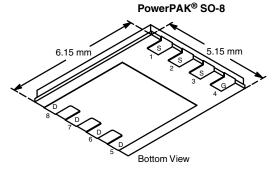
COMPLIANT

HALOGEN FREE

Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) (Max.)	I _D (A) ^{a, g}	Q _g (Typ.)		
30	0.0043 at V _{GS} = 10 V	25	13.6 nC		
	0.0060 at V_{GS} = 4.5 V	25	13.0110		

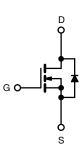


FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Gen IV Power MOSFET
- 100 % R_{α} and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- High Power Density DC/DC
- Synchronous Rectification
- VRMs and Embedded DC/DC



N-Channel MOSFET

Ordering Information:

SiRA12DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	30	v	
Gate-Source Voltage		V _{GS}	+ 20, - 16		
	T _C = 25 °C		25 ^g	A	
Continuous Drain Current (T ₁ = 150 °C)	T _C = 70 °C	I_	25 ^g		
Continuous Drain Current $(T_j = 150^{\circ} C)$	T _A = 25 °C	I _D	25 ^{b, c, g}		
	T _A = 70 °C		20 ^{b, c}		
Pulsed Drain Current (t = 300 μs)		I _{DM}	80	- A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1.	25 ^g		
Continuous Source-Drain Diode Current	T _A = 25 °C	۱ _s	3.8 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	15		
Single Pulse Avalanche Energy	L = 0.1 IIIH	E _{AS}	11	mJ	
	T _C = 25 °C		31		
Movimum Dower Discinction	T _C = 70 °C	P _D	20	w	
Maximum Power Dissipation	T _A = 25 °C	'D	4.5 ^{b, c}		
	T _A = 70 °C		2.9 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature		260			

THERMAL RESISTANCE RATINGS Parameter Symbol Typical Maximum Maximum Junction-to-Ambientb, f t ≤ 10 s R_{thJA} 25 28 Maximum Junction-to-Case (Drain) Steady State 3.2 4

Notes:	
110105.	

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

R_{thJC}

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 70 °C/W.

g. Package limited.

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Unit

°C/W

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	· ·						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Γ		16			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.1		2.2	V	
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = + 20, - 16 V			± 100	nA	
-		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	25			Α	
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 10 A		0.0032	0.0043	Ω	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.0044	0.0060		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 10 A		51		S	
Dynamic ^b	<u> </u>						
Input Capacitance	C _{iss}			2070		pF	
Output Capacitance	C _{oss}			600			
Reverse Transfer Capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		51			
C _{rss} /C _{iss} Ratio				0.025	0.050		
	Q _g	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		29.5	45	nC	
Total Gate Charge				13.6	21		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		5.2			
Gate-Drain Charge	Q _{gd}			2.6			
Output Charge	Q _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$		16			
Gate Resistance	R _g	f = 1 MHz	0.3	1.7	3.4	Ω	
Turn-On Delay Time	t _{d(on)}			10	20		
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		10	20	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		25	50		
Fall Time	t _f			10	20		
Turn-On Delay Time	t _{d(on)}			20	40	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		15	30	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		22	45		
Fall Time	t _f	1 –		10	20	1	
Drain-Source Body Diode Characteristic	s				<u> </u>		
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C		25			
Pulse Diode Forward Current ^a	I _{SM}				80	— A	
Body Diode Voltage	V _{SD}	I _S = 10 A		0.86	1.2	V	
Body Diode Reverse Recovery Time t _{rr}				27	55	ns	
Body Diode Reverse Recovery Charge Q _{rr}		I _F = 10 A, dl/dt = 100 A/μs,		15	30	nC	
Reverse Recovery Fall Time	t _a	T _J = 25 °C		13		1	
Reverse Recovery Rise Time	t _b			14		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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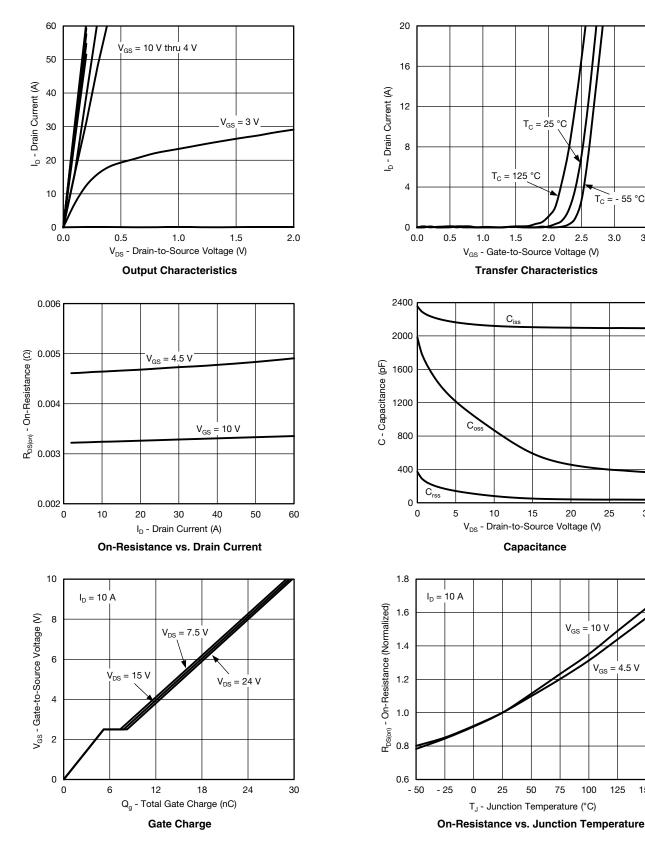


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3.5

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



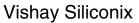
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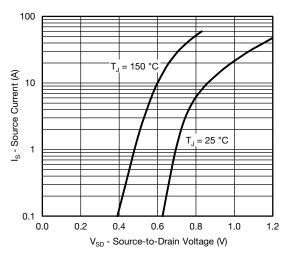
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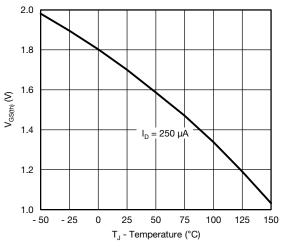




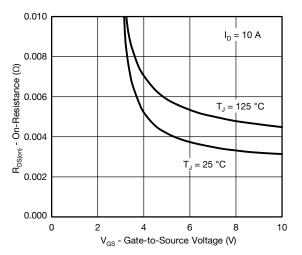
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



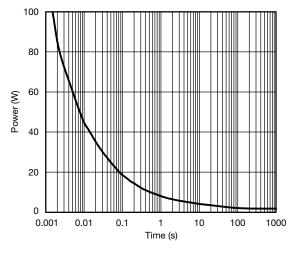
Source-Drain Diode Forward Voltage



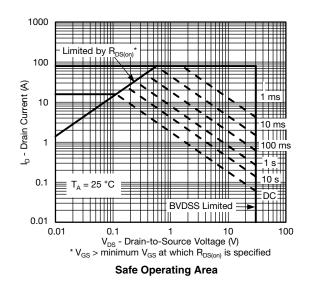
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



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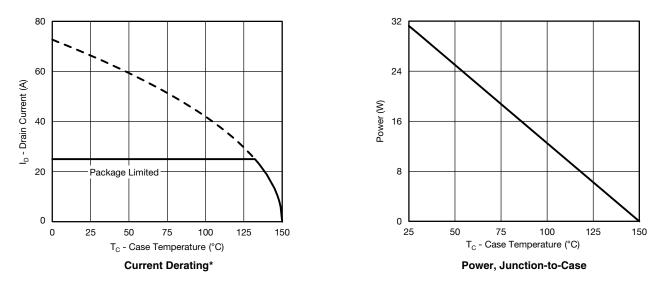
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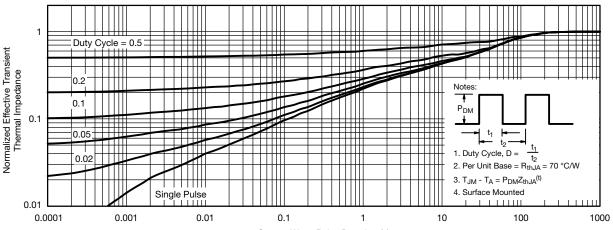


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

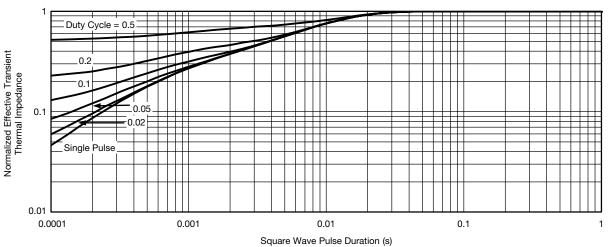


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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